RoHS

COMPLIANT

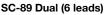
HALOGEN

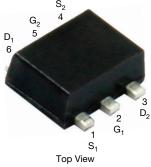


Vishay Siliconix

Complementary N- and P-Channel 20 V (D-S) MOSFET

PRODU	CT SUMMARY				
	V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.)	
	20	0.396 at V _{GS} = 4.5 V	0.50		
N-Channel		0.456 at V _{GS} = 2.5 V	0.20	0.75 nC	
N-Channel		0.546 at V _{GS} = 1.8 V	0.20	0.75110	
		0.760 at V _{GS} = 1.5 V	0.05		
	-20	0.756 at V _{GS} = -4.5 V	-0.35		
P-Channel		1.038 at V_{GS} = -2.5 V	-0.35	1 nC	
r-onannei		1.440 at V_{GS} = -1.8 V	-0.10		
		2.400 at V _{GS} = -1.5 V	-0.05		





Marking Code: 5

Ordering Information:

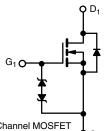
Si1016CX-T1-GE3 (Lead (Pb)-free and Halogen-free)

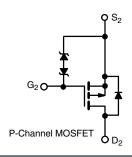
FEATURES

- TrenchFET[®] power MOSFETs
- High-side switching
- Ease in driving switches
- Low offset (error) voltage
- Low-voltage operation
- High-speed circuits
- Typical ESD protection: n-channel 900 V, p-channel 900 V (HBM)
- 100 % Rg tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Load switch, small signal switches and level-shift switches
 - Battery operated systems
 - Portable





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T	_A = 25 °C, unless	s otherwise n	oted)			
PARAMETER	SYMBOL	N-CHANNEL	P-CHANNEL	UNIT		
Drain-Source Voltage	V _{DS}	20	-20	v		
Gate-Source Voltage		V _{GS}	± 8		v	
Continuous Drain Current (T, = 150 °C)	T _A = 25 °C	I _D	0.6 ^{a, b}	-0.6 ^{a, b}		
Continuous Drain Current $(1j = 150^{\circ} C)$	T _A = 70 °C		0.49 ^{a, b}	-0.49 ^{a, b}	A	
Pulsed Drain Current (t = 300 µs)		I _{DM}	2	-1.5	A	
Source Drain Current Diode Current	T _A = 25 °C	I _S	0.18 ^{a, b}	-0.18 ^{a, b}		
Maximum Power Dissipation	T _A = 25 °C	Р	0.22 ^{a, b}	0.22 ^{a, b}	w	
	T _A = 70 °C	P _D	0.14 ^{a, b}	0.14 ^{a, b}	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	

THERMAL RESISTANCE RATINGS **P-CHANNEL N-CHANNEL** PARAMETER SYMBOL UNIT MAX. TYP. MAX. TYP. 470 t ≤ 5 s 470 565 565 Maximum Junction-to-Ambient a, c °C/W **R**_{thJA} Steady State 560 675 560 675

Notes

a. Surface mounted on 1" x 1" FR4 board.

b. t = 5 s.

c. Maximum under steady state conditions is 675 °C/W.

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Si1016CX

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					1			
		V _{GS} = 0 V, I _D = 250 µA	N-Ch	20	-	-		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	P-Ch	-20	-	-	V	
		$I_D = 250 \mu\text{A}$	N-Ch	-	17	-		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	$I_{\rm D} = -250 \mu{\rm A}$	P-Ch	-	-12	_	-	
		$I_{\rm D} = 250 \mu{\rm A}$	N-Ch	-	-1.8	_	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	P-Ch	-	1.8	-		
		$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	N-Ch	0.4	-	1		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	P-Ch	-0.4	-	-1	V	
		VDS = VGS, ID = 200 p. (N-Ch	-	-	±1		
		V_{DS} = 0 V, V_{GS} = ± 4.5 V	P-Ch	_	_	±1	-	
Gate-Source Leakage	I _{GSS}		N-Ch	-	_	± 30		
		V_{DS} = 0 V, V_{GS} = ± 8 V	P-Ch	-	_	± 30	-	
		$V_{DS} = 20 V, V_{GS} = 0 V$	N-Ch	-	_	1	μA	
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	P-Ch	-	-	-1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$	N-Ch	-	-	10	-	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$	P-Ch	-	-	-		
			-	2	-	-10 -		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 4.5 V$	N-Ch P-Ch	∠ -1.5		-	A	
		$V_{DS} \le -5 V, V_{GS} = -4.5 V$	-	-	-	-		
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	N-Ch	-	0.330	0.396	- Ω	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -0.35 \text{ A}$	P-Ch	-	0.630	0.756		
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$	N-Ch	-	0.380	0.456		
Drain-Source On-State Resistance ^b		$V_{GS} = -2.5 \text{ V}, \text{ I}_D = -0.35 \text{ A}$	P-Ch	-	0.865	1.038		
		$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$	N-Ch	-	0.420	0.546		
		$V_{GS} = -1.8 \text{ V}, \text{ I}_{D} = -0.1 \text{ A}$	P-Ch	-	1.200	1.440		
		$V_{GS} = 1.5 \text{ V}, \text{ I}_{D} = 0.05 \text{ A}$	N-Ch	-	0.505	0.760		
		$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -0.05 \text{ A}$	P-Ch	-	1.600	2.400		
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	N-Ch	-	2	-	s	
		V _{DS} = -10 V, I _D = -3.6 A	P-Ch	-	1	-	+	
Input Capacitance	C _{iss}		N-Ch	-	43	-		
		N-Channel $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	P-Ch	-	45	-		
Output Capacitance	Coss	$v_{\rm DS} = 10 v, v_{\rm GS} = 0 v, 1 = 10012$	N-Ch	-	14	-	pF	
		P-Channel	P-Ch	-	15	-		
Reverse Transfer Capacitance	C _{rss}	V_{DS} = -10 V, V_{GS} = 0 V, f = 1 MHz	N-Ch	-	8	-		
	100		P-Ch	-	10	-		
Dynamic ^a			T	[1	-	1	
		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.6 \text{ A}$	N-Ch	-	1.3	2		
Fotal Gate Charge	Qg	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -0.4 \text{ A}$	P-Ch	-	1.65	2.50		
	g		N-Ch	-	0.75	1.2	4	
		N-Channel	P-Ch	-	1	2	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 2.5 \text{ V}, I_D = 0.6 \text{ A}$	N-Ch	-	0.15	-		
	∽gs	P-Channel	P-Ch	-	0.2	-	-	
Gate-Drain Charge	Q _{gd}	V_{DS} = -10 V, V_{GS} = -2.5 V, I_{D} = -0.4 A	N-Ch	-	0.13	-		
	∽gd		P-Ch	-	0.26	-		
Cata Resistance	D	f = 1 MHz	N-Ch	2.4	12.2	24.4	0	
Gate Resistance	R _g		P-Ch	2.4	12	24	Ω	

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PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS			TYP.	MAX.	UNIT
Dynamic ^a							
Turn-On Delay Time	t _{d(on)}		N-Ch	-	11	20	
	-0(01)	N-Channel	P-Ch	-	9	18	
Rise Time	tr	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 20 \Omega$	N-Ch	-	16	24	20 39 20
		$\text{I}_\text{D}\cong$ 0.5 A, V_GEN = 4.5 V, R_g = 1 Ω	P-Ch	-	10	20	
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch	-	26	39	
	G(OII)	V_{DD} = -10 V, R _L = 33.3 Ω I _D ≅ -0.3 A, V _{GEN} = -4.5 V, R _a = 1 Ω	P-Ch	-	10	20	
Fall Time	t _f	D = 0.073, 0 GeV = 1.000, 100 GeV = 1.000	N-Ch P-Ch	-	11	20	
			N-Ch	-	8	4	ns
Turn-On Delay Time	t _{d(on)}		P-Ch	-	2	4	
		N-Channel $M = 10 M R = 20 O$	N-Ch		-	20	
Rise Time	t _r			-	16		
		$\begin{array}{l} \mbox{P-Channel} \\ \mbox{V}_{DD} = -10 \mbox{ V, } R_L = 33.3 \ \Omega \\ \mbox{I}_D \cong -0.3 \mbox{ A, } \mbox{V}_{GEN} = -8 \mbox{ V, } R_g = 1 \ \Omega \end{array}$	N-Ch	_	7	14	-
Turn-Off Delay Time	t _{d(off)}		P-Ch	-	9	18	
	t _f		N-Ch	-	5	10	
Fall Time			P-Ch	-	5	10	
Drain-Source Body Diode Characterist	ics						
Pulse Diode Forward Current ^a	I _{SM}		N-Ch	-	-	2	А
			P-Ch	-	-	-1.5	.5 A
Body Diode Voltage	V _{SD}	$I_{S} = 0.5 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch	-	0.85	1.2	v
Body Diode Voltage		$I_{S} = -0.3 \text{ A}, V_{GS} = 0 \text{ V}$	P-Ch	-	-0.87	-1.2	v
Body Diode Reverse Recovery Time	t _{rr}		N-Ch	-	10	20	ns
		N-Channel	P-Ch	-	16	24	
ody Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm F} = 0.5 \rm A,$	N-Ch	-	2	4	nC
,, enalge		dl/dt = 100 A/µs, T _J = 25 °C	P-Ch	-	8	20	
Reverse Recovery Fall Time	ta	P-Channel	N-Ch	-	5	-	
· · · · · · · · · · · · · · · · · · ·		I _F = -0.3 A, dl/dt = -100 A/μs, T _I = 25 °C	P-Ch	-	11	-	ns
Reverse Recovery Rise Time	t _b	$a_{0}a_{1} = -100 \text{ Av} \mu_{3}, 1j = 20 \text{ O}$	N-Ch	-	5	-	
			P-Ch	-	5	-	

Notes

a. Guaranteed by design, not subject to production testing.

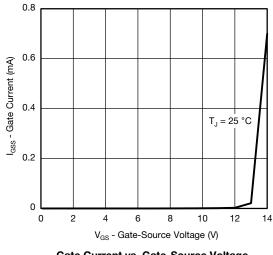
b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

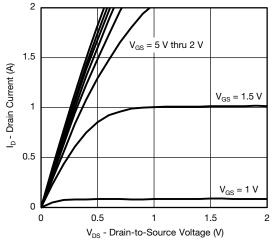
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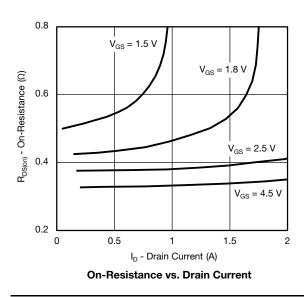
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

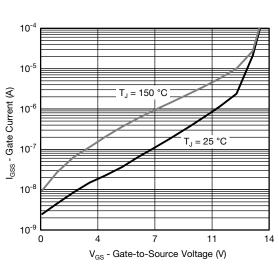


Gate Current vs. Gate-Source Voltage

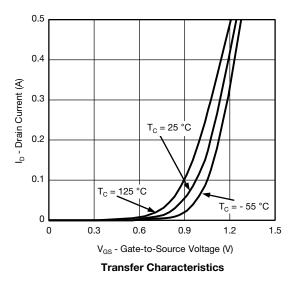


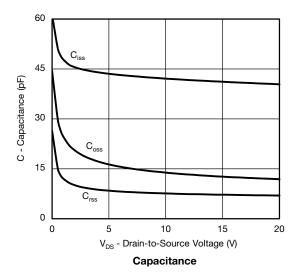






Gate Current vs. Gate-Source Voltage



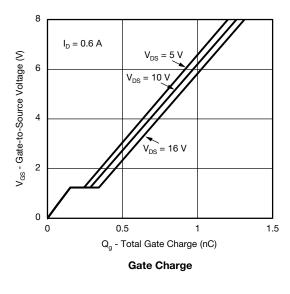


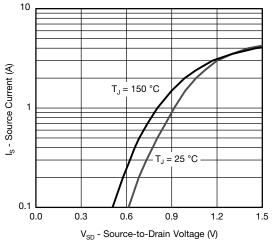
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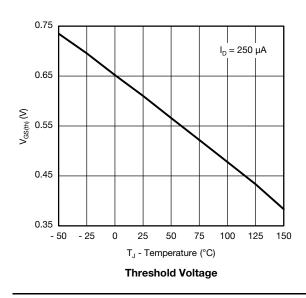


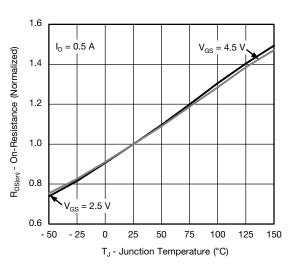
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



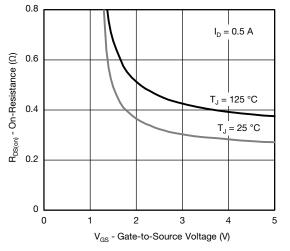


Source-Drain Diode Forward Voltage

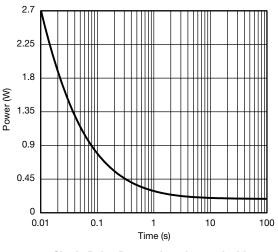




On-Resistance vs. Junction Temperature







Single Pulse Power, Junction-to-Ambient

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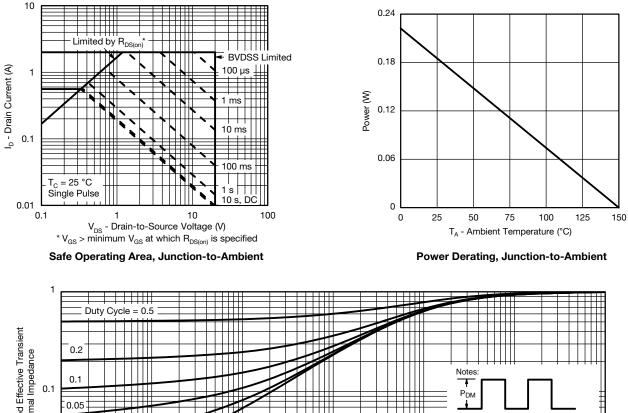
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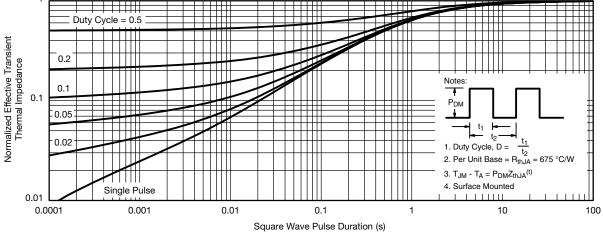
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N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

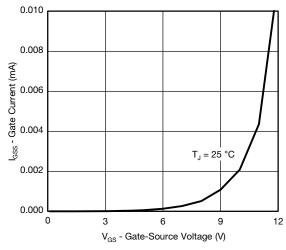




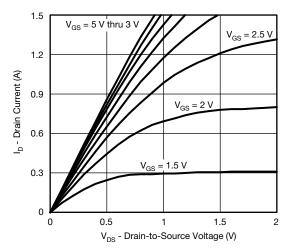
Normalized Thermal Transient Impedance, Junction-to-Ambient



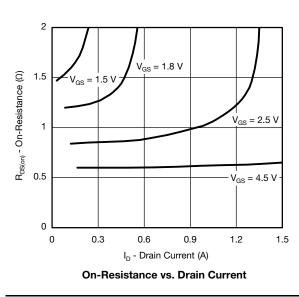
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

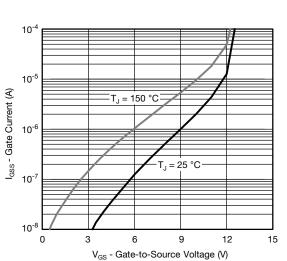


Gate Current vs. Gate-Source Voltage

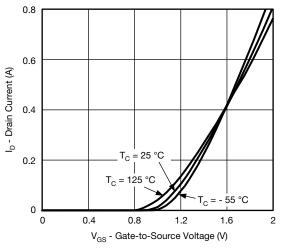


Output Characteristics

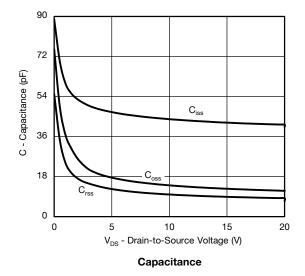




Gate Current vs. Gate-Source Voltage



Transfer Characteristics



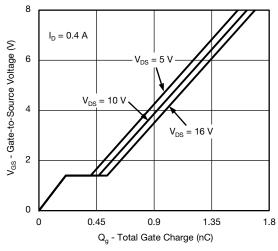
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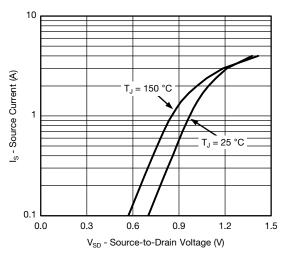


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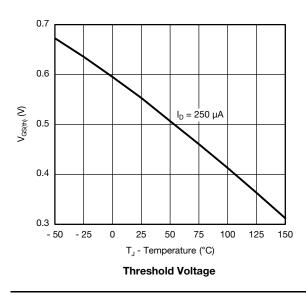
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

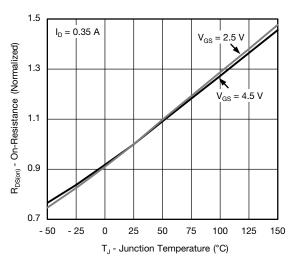




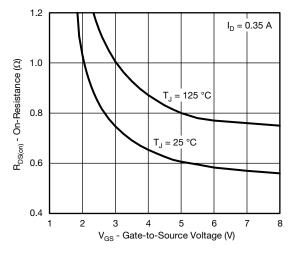


Source-Drain Diode Forward Voltage

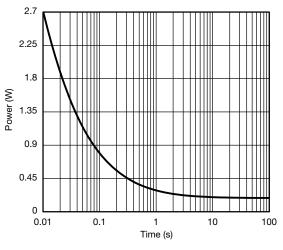




On-Resistance vs. Junction Temperature









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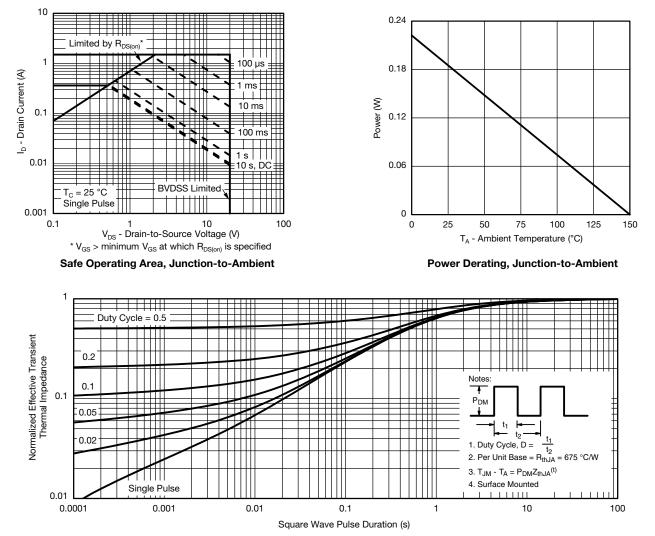
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P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



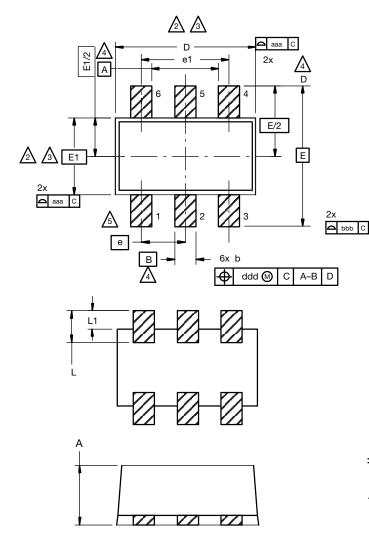
Normalized Thermal Transient Impedance, Junction-to-Ambient

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SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

A Datums A, B and D to be determined 0.10 mm from the lead tip.

A Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS					
	MIN.	NOM.	MAX.			
А	0.56	0.58	0.60			
A1	0	0.02	0.10			
b	0.15	0.22	0.30			
С	0.10	0.14	0.18			
D	1.50	1.60	1.70			
E	1.50	1.60	1.70			
E1	1.15	1.20	1.25			
е	0.45	0.50	0.55			
e1	0.95	1.00	1.05			
L	0.25	0.35	0.50			
L1	0.10	0.20	0.30			
C14-0439-Rev DWG: 5880	v. C, 11-Aug-14					

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

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Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.